

F

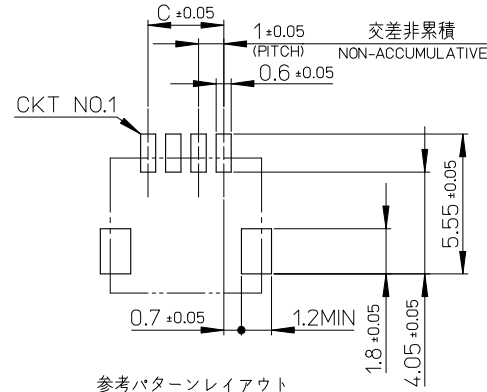
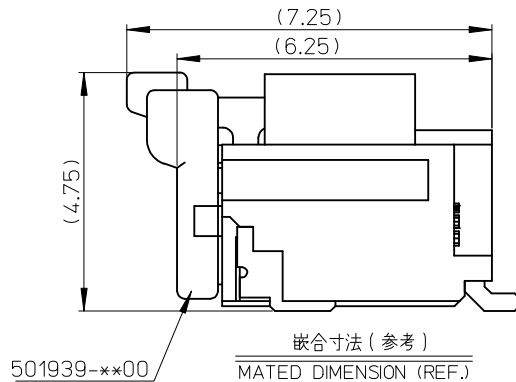
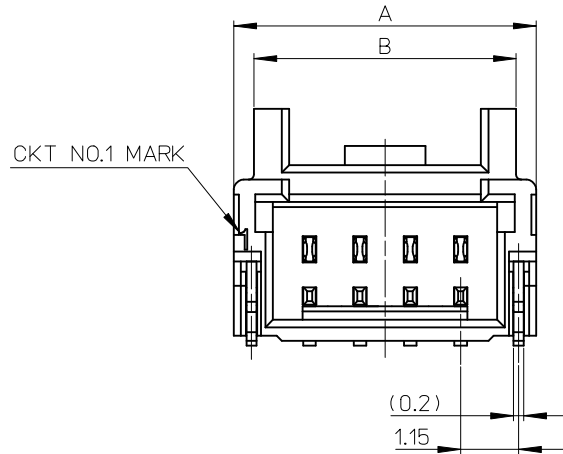
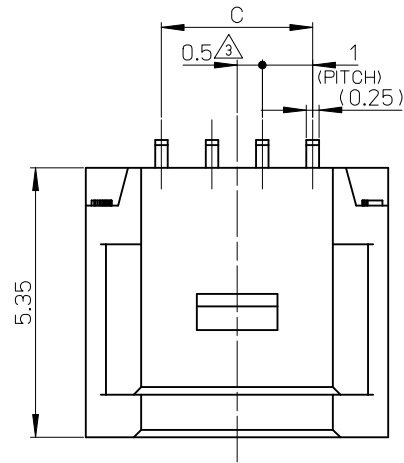
E

D

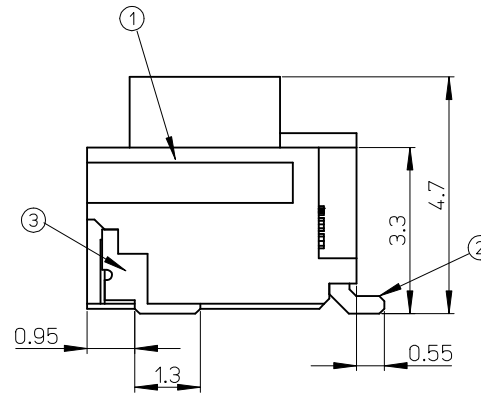
C

B

A



参考パターンレイアウト
RECOMMENDED PATTERN DIM. (REF)
SCALE 5:1



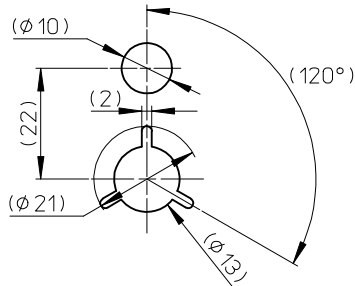
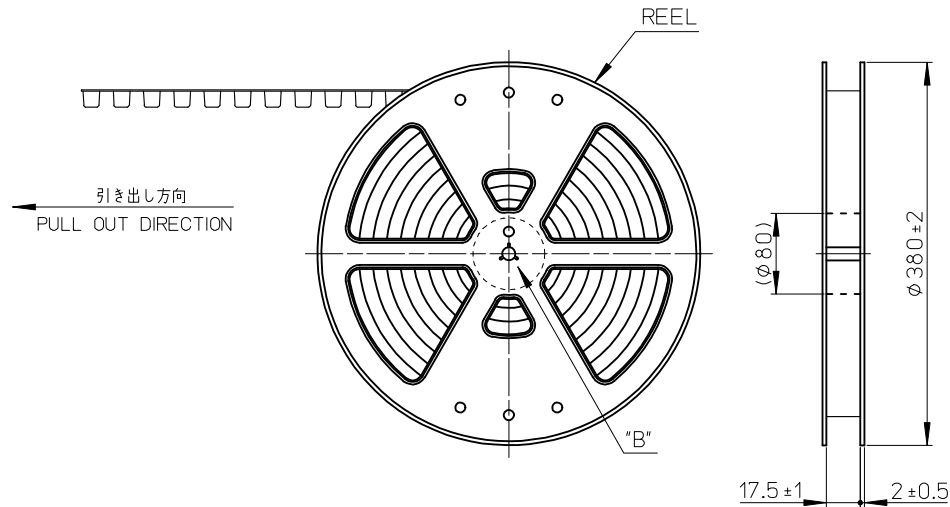
NOTES.

1. 嵌合相手: 501939-****
MATE WITH: 501939-****
2. ソルダーピン及びネイル平坦度は、0.1 MAX.
SOLDER PIN AND NAIL COPLANARITY TO BE 0.1 MAX.
- △ 極数=偶数に適用
APPLY FOR CKT SIZE=EVEN
4. ELV AND RoHS COMPLIANT.

4.0	5.2	7.0	5
3.0		6.0	4
2.0	4.2	5.0	3
C	B	A	極数 CIRCUITS

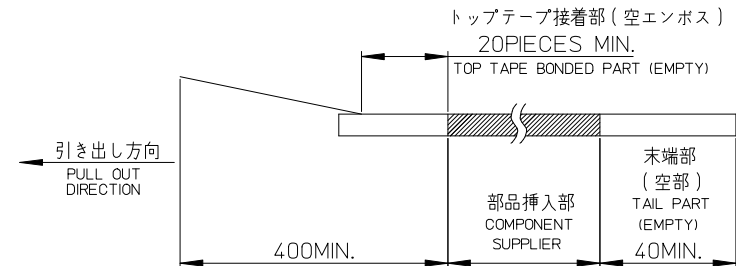
REVISED EC NO: J2010-0339 T DRWN: TNAKAWA01 2009/09/01 CHKD: MATSUMOTO 2009/09/01 APPR: HIRATA 2009/09/01	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 10:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION
		10 UNDER	± 0.2	DRAWN BY NYOSHIDA	DATE 2005/09/16	TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y 1-ROW R/A POSI-LOCK		
		10 OVER 30 UNDER	± 0.25	CHECKED BY AMIZUMURA	DATE 2005/09/16			
		30 OVER	± 0.3	APPROVED BY MYAGI	DATE 2005/09/16			
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 2		SD-501953-001		1 OF 2	
	REV	SIZE A3 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

[illegible]



NOTES

- 製品詳細寸法は製品単体図面を参照して下さい。
FOR DETAIL OF CONNECTOR DIMENSIONS, PLEASE SEE THE DRAWING OF CONNECTOR ITSELF (NOT PACKAGED).
- 梱包数量: 1300個/リール
NUMBER OF CONNECTORS: 1300PIECES/REEL
- リードテープ長さ
LEAD TAPE LENGTH



4. 材料

MATERIAL

キャリアテープ: ポリスチレン

CARRIER TAPE: POLYSTYRENE

トップテープ: PET、その他

TOP TAPE: PET, OTHER

リール: ポリスチレン<リサイクル材を含む>

REEL: POLYSTYRENE <RECYCLE MATERIAL CONTAINED>

5. ELV AND RoHS COMPLIANT.

6. ハイバリア梱包 (シリカゲル入り) 対応品である。(501953-**07除く)

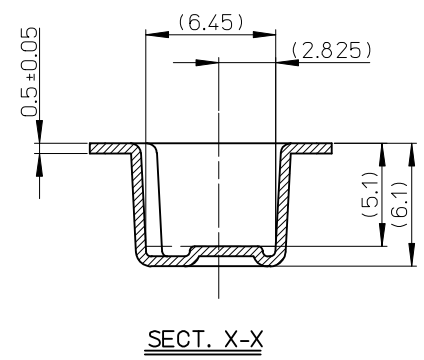
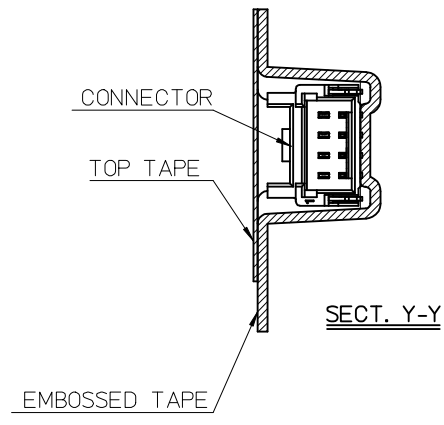
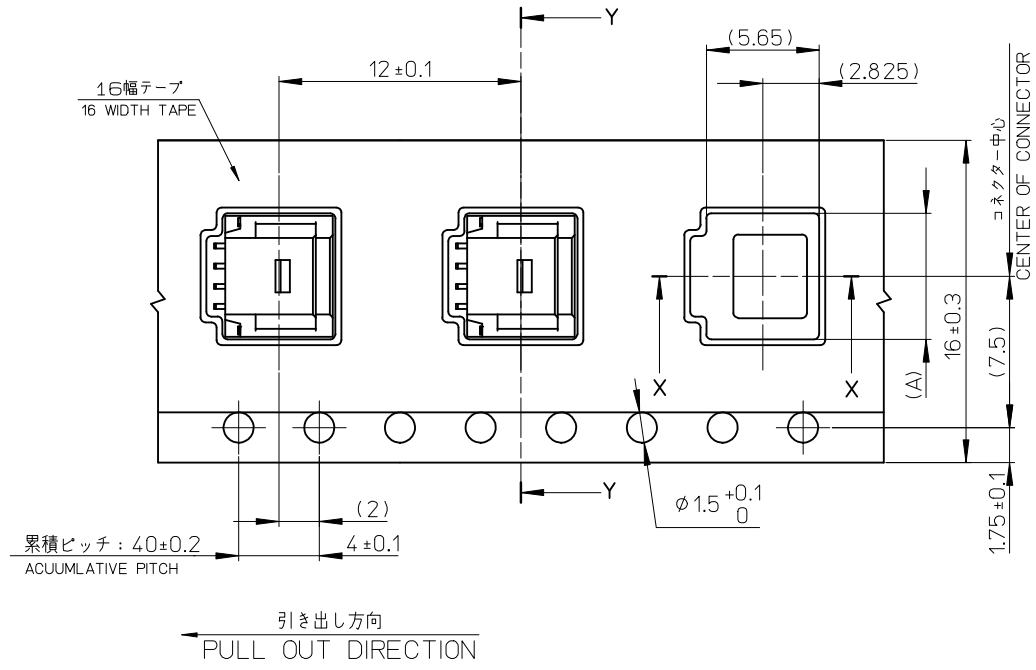
THIS PRODUCT IS HIGH BARRIER PACKAGE.(WITH SILICAGEL)
(BESIDES 501953-**07)

7. 開梱後の保管条件に注意のこと。(ハイバリア品対象: PS-501940-001参照)

REFER TO PS-501940-001(HIGH BARRIER PRODUCT)
FOR CONDITIONS AFTER OPEN.

REVISED	EC NO: J2010-0339 DRWN: TNAKAGAWA01 2009/09/01 CHKD: HIRATA SUMOTO 2009/09/01 APPR: HIRATA 2009/09/01	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	 THIRD ANGLE PROJECTION	
					MM ONLY		---	METRIC		
			10 UNDER	± 0.2	DRAWN BY	DATE	TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y 1-ROW R/A EMBSTP PKG			
			10 OVER 30 UNDER	± 0.25	CHECKED BY	DATE				
			30 OVER	± 0.3	AMIZUMURA	2005/09/16				
			ANGULAR ±3 °		APPROVED BY	DATE	 MOLEX INCORPORATED			
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MYAGI	2005/09/16				
					MATERIAL NO.		DOCUMENT NO.	SHEET NO.		
					SEE SHEET 3		SD-501953-002		1 OF 3	
			G	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

CONFIDENTIAL



7.3	5
6.3	4
5.3	3
(A)	極数 CIRCUITS

REVISED EC NO: J2010-0339 G DRWN: TNAGAWA01 2009/09/01 CHKD: MATSUMOTO 2009/09/01 APPR: HIRATA 2009/09/01	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY NYOSHIDA	DATE 2005/09/16	TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y 1-ROW R/A EMBSTP PKG				
		10 OVER 30 UNDER	± 0.25	CHECKED BY AMI ZUMURA	DATE 2005/09/16					
		30 OVER	± 0.3	APPROVED BY MYAGI	DATE 2005/09/16	MOLEX MOLEX INCORPORATED				
		ANGULAR ± 3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 3		SD-501953-002		2 OF 3			
	REV				SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

